

ITE	M DES	SC .	Q'TY	METE	METERIALS T		EATMENT	REMARK
1	STE	M	1		IGH-TEMP HERMOPLASTIC A9T UL 94V-0		-	-
2	CONTA	ACT	1	SUS301	CSP-EH	With	Silver Plating	-
3	BAS	Ε	1	HIGH-TEMP THERMOPL NTLON UL 9	ASTIC	MOL	DED BLACK	-
4	TERMI	NAL	1	BRA	ASS	With	Silver Plating	-
5	LEC)	1	_	_		NONE	-
6	TAP	Е	1	TEFI	LON		-	
TL L T		- <u></u>	-	B: T/ V: T:	ackage: =Tube /R=Tape & R =Lead Free =Tape(only fo]= Without Ta =Super Light	or S.M.T)	r S.M.T) ⁴	
				S	ee note LED	Color:	3	2
	LED Specification Departing Force							
С	增加貼膠帶工站			TITLE			APPD. :	
В	新增規格TLLM	邱明義			ILE SWITCH	I TYPE	CHKD. :	
A	DWG.REL	邱明義			VO. : TL(L)□-6□		PR. : PAG	GY
REV.		APPD.		FILE NO			REV. : C	SHEET : 1/1

LED Color	
Single lamp	Double-Loop lamp
PG=Pure green	RG= Yellow green\ Red
R=Red	BG=Bule \ Green
B=Blue	AG= Amber\Green
G=Green	RB=Red\ Blue
Y=Yellow	AB= Amber\ Blue
W=White	RW=Red\White
A=Amber	BY= Blue \ Yellow
	BA=Bule\Amber
	APG=Amber\Pure green
	WY= White \ Yellow

С	增加貼膠帶工站	
В	新增規格TLLM	邱明義
Α	DWG.REL	邱明義
REV.	ECO. NO.	APPD.

TITLE	APPD.	:				
TACTILE SWITCH TYPE	CHKD.	:				
PRROD. NO. : TL(L) - 6 V	PR.	:	PAG	GY		
FILE NO. : E-V-CT20	REV.	:	С	SHEET	:	1/1

表單編號: S-236 <EA-020>

	FILE No.	:	E	-V-AT	-V-AT10 D / 5
TL(L) -6 -SV SPECIFICATION	REV.	:		D	
· ,— ——	Page	:	1	/	5

1. Style

This specification describes"TACTILE SWITCH", mainly used as signal switch of electric devices, with the general requirements of mechanical and electrical characteristic.

1.1 Operating Temperature Range : -25 °C ~+70°C

1.2 Storage Temperature Range : -30°C ~+80°C

1.3 The shelf life of product is within 6 months.

Current Range: 50mA, 12V DC Please refer LED rating from LED spec

3. Type of Actuation: Tactile feedback

4. Test Sequence:

	ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS		
APPEARANCE	1	Visual Examination	By visual examination check without any out pressure & testing	There shall be no defects that affect the serviceability of the product.		
	2	Contact Resistance	Applying a static load 1.5-2 times the operating force to the center of the stem, measurements shall be made with a 1 kHz small current contact resistance meter	100mΩ Max		
PERFORMANCE	3	Insulation Resistance	Inotential across terminals and cover 110 000 min			
	4	Dielectric Withstanding Voltage	ectric 250 V AC(50Hz or 60Hz) shall be applied across terminals and cover breakdown or fla			
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	5	Capacitance	1 MHz ±10 kHz	5 pF max.		
ELECTRIC	6	Bounce	3 to 4 operations at a rate of 1 cycles per second Switch Synchroscope 5V DC 5ΚΩ	5 m seconds max.		

	-S-U-V SPECIFICATION FILE No. : REV. Page :	:	E-	-V-AT1	0
TL(L) -6 -SV SPECIFICATION	REV.	:		D	
	Page	• •	2	/	5

	7	Operating Force	Applied in the direction of operation	100 ±50g [.98 ±.49N]	160 ±50g [1.568 ±.49N]	260 ±50g [2.548 ±.49N]	520 ±130g [5.1 ±1.27N]	
	8	Stroke	Placing the switch such that the direction of switch operation is vertical and then gradually increasing the load applied to the stem, the stroke distance for the stem to come to a stop shall be measured	0.20±0.10mm				
PERFORMANCE	9	Stop Strength	Placing the switch such that the direction of switch operation is vertical, a static load of 3 kgf (29.4N)shall be applied in the direction of stem operation for a period of 15 seconds	©Conta 200m 3Insula	 ①As shown in item 4~7 ②Contact Resistance: 200mΩ Max ③Insulation Resistance: 10MΩ min 			
MECHANICAL PE	10	Solder Heat Resistance	 ■Through Hole Type ①Soldering Temperature:260±5°C ②Duration of Solder Immersion: 5±1 seconds ③Frequency of Soldering Process 2 times max. (PCB is 1.6mm in thickness) ■SMT Type ~ Series(4/4) 	 Shall be free from pronounced backlash a falling-off or breakage terminals As shown in item 4 \ 5 Contact Resistance: 200mΩ Max Insulation Resistance: 10MΩ min 			ge 、5	
	11	Vibration	Shall be vibrated in accordance with Method 201A of MIL-STD-202F ①Swing distance=1.5mm ②Frequency: 10-55-10Hz in 1-min/cycle. ③Direction: 3 vertical directions including the directions of operation ④Test time: 2 hours each direction	①As shown in item 4~7 ②Contact Resistance: 200mΩ Max ③Insulation Resistance: 10MΩ min				
MECHANICAL PERFORMANCE	12	Shock	Shall be shocked in accordance with Method 213B condition A of MIL-STD-202F 1)Acceleration; 50G 2)Action time:11±1m seconds 3)Testing Direction: 6 sides 4)Test Cycle: 3 times in each direction	Ditto				

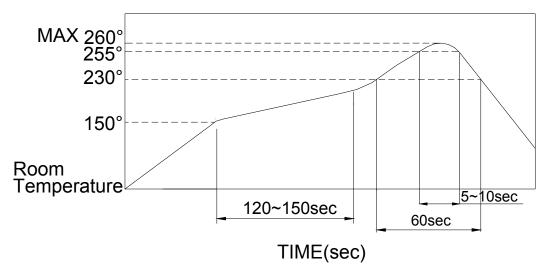
	FILE No.	:	E-	-V-AT1	10
TL(L) -6 -SV SPECIFICATION	REV.	:		D	
	Page	:	3	/	5

ш			1)Through Hole Soldering Temperature : 245±3°ℂ	No anti-soldering and the
MECHANICAL PERFORMANCE	13	Solderability	Lead-Free solder: M705E JIS Z 3282 A (Tin 96.5%, Silver 3%, Copper 0.5%) 2)Flux: 5~10 sec	coverage of dipping into solder must more than 66% were requested.
ME			3)Duration of solder Immersion: 5±1 sec	
DURABILITY	14	Operating Life	Measurements shall be made following the test forth below: 1)5mA,5 VDC resistive load 2)Applying a static load the operating force to the center of the stem in the direction of operation Static Load = OF Max. 3)Cycle of Operation: 500,000 cycles min~100 \ 160g 200,000 cycles min.~260g	 1.As shown in item 4 · 5 2.Operating force:±50% of initial force. 3.Contact Resistance: 10Ω Max 4.Insulation Resistance: 10ΜΩ min 5.Bounce: 10 m seconds Max
	15	Resistance Low	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for 1 hour before the measurements are made: 1)Temperature:-25±3°C 2)Time: 96 hours	①As shown in item 4~7②Contact Resistance: 200mΩ Max③Insulation Resistance: 10MΩ min
WEATHER-PROOF	16	Heat Resistance	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for 1 hour before the measurements are made: 1)Temperature:80±2°C 2)Time: 96 hours	Ditto
W	17	Humidity Resistance	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for 1 hour before the measurements are made: 1)Temperature:40±2°C 2)Relative Humidity: 90~95% 3)Time: 96 hours	Ditto

	FILE No.		E-	-V-AT	10
TL(L) -6 -SV SPECIFICATION	REV.	:		D	
• •	Page	:	4	/	5

5. SOLDERING CONDITIONS:

■ Condition for Reflow Soldering – S.M.T Series



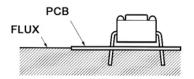
- The condition mentioned above is the temperature on the Cu foil of the PCB surface. There are cases where board's temperature greatly differs from switch's surface be used not to allow switch's surface temperature to exceed 260°C.
- Manual Soldering

Soldering Temperature	Max.350°ℂ
Continuous Soldering Time	Max. 5 seconds

- Precautions in Handling
 - 1. Care should be exercised so that flux from the upper part of the printed circuit board does not adhere to the switch.
 - 2. Except for washable type do not wash the switch.

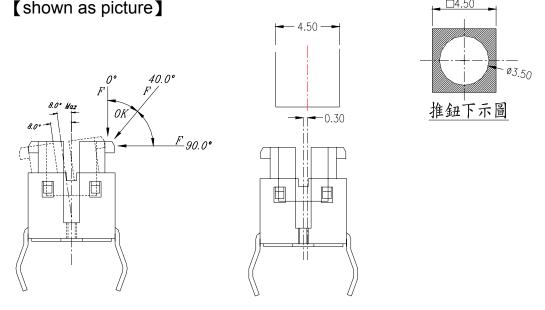


4. Please make sure that there is no flux rose over the surface of the PCB.



TL(L) -6 -S--V SPECIFICATION FILE No. REV. D Page : 5 / 5

5. When the angle between the operation direction "F" and switch is over 40 degree (4 direction), there may be some concerns about the function.



- 6. After reflow, do not touch LED before cooling ,or it could influence LED function.
- 7. It is a normal material characteristic when whiting on plastic after reflow
- Notes on storage conditions:

Do not store in the following environment or it may affect product's function and solderbility:

- 1. temperature of -10 (max) \sim +40 (min) $^{\circ}$ C & humidity at 85% (min)
- 2. environment with corrosive gas
- 3. storage over 6 months
- 4. place of direct sunlight

Store with proper packaging conditions and to avoid loading heavy force

We suggest to use the products within 3 months or at least 6 months.

After opening the package, the rest products must be stored in the appropriate moisture-proof & airtight environment